

LTC1385

3.3V Low Power EIA/TIA-562 Transceiver

FEATURES

- Operates from a Single 3.3V Supply
- Low Supply Current: I_{CC} = 200µA
- $I_{CC} = 35 \mu A$ in Driver Disable Mode
- I_{CC} = 0.2µA in Shutdown Mode
- ESD Protection Over ±10kV
- Uses Small Capacitors: 0.1µF
- Operates to 120kBaud
- Output Overvoltage Does Not Force Current Back into Supplies
- EIA/TIA-562 I/O Lines Can Be Forced to ±25V Without Damage
- Pin Compatible with LT1180A

TYPICAL APPLICATION

APPLICATIONS

- Notebook Computers
- Palmtop Computers

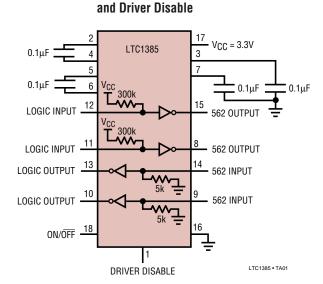
DESCRIPTION

The LTC[®]1385 is an ultra-low power, 2-driver/2-receiver EIA/TIA-562 transceiver which operates from a single 3.3V supply. The charge pump requires only four space-saving 0.1μ F capacitors.

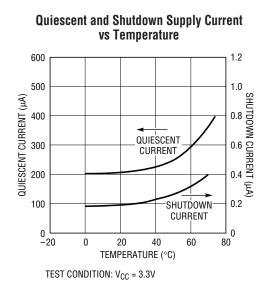
The transceiver operates in one of three modes: Normal, Driver Disable or Shutdown. In the Normal mode, I_{CC} is only 200µA in the unloaded condition. In the Driver Disable mode, the charge pump is turned off, the driver outputs are forced into three-state, both receivers are kept active, and I_{CC} drops to 35µA. In the Shutdown mode, everything is turned off and I_{CC} drops to 0.2µA.

The LTC1385 is fully compliant with all data rate and overvoltage EIA/TIA-562 specifications. The transceiver can operate up to 120kbaud with a 1000pF, $3k\Omega$ load. Both driver outputs and receiver inputs can be forced to $\pm 25V$ without damage, and can survive multiple $\pm 10kV$ ESD strikes.

C, LTC and LT are registered trademarks of Linear Technology Corporation.



2-Drivers/2-Receivers with Shutdown



LTC1385 • TA02

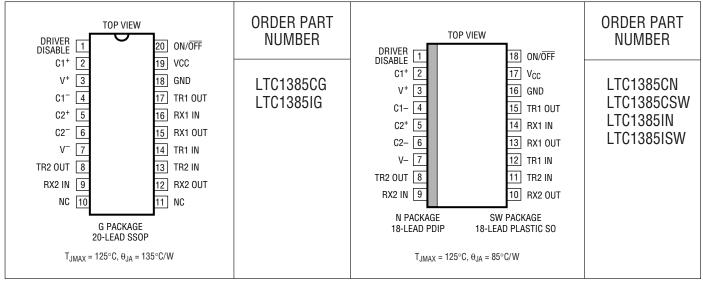


ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V _{CC})	5V
Input Voltage	
Driver	$-0.3V$ to V _{CC} + 0.3V
Receiver	25V to 25V
Digital Input	$-0.3V$ to V _{CC} + 0.3V
Output Voltage	
Driver	– 25V to 25V
Receiver	$-0.3V$ to V _{CC} + 0.3V

Short-Circuit Duration
V ⁺
V ⁻
Driver Output Indefinite
Receiver Output Indefinite
Operating Temperature Range
LTC1385C 0°C to 70°C
LTC1385I – 40°C to 85°C
Storage Temperature Range –65°C to 150°C
Lead Temperature (Soldering, 10 sec) 300°C

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

DC ELECTRICAL CHARACTERISTICS The • denotes specifications which apply over the full operating

temperature range. $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1 \mu F$, $V_{ON/OFF} = V_{CC}$, Driver Disable = V_{CC} , unless noted.

PARAMETER	CONDITIONS			MIN	ТҮР	MAX	UNITS
Any Driver							
Output Voltage Swing	3k to GND	Positive Negative	•	3.7 -3.7	4.5 - 4.5		V V
Logic Input Voltage Level	Input Low Level (V _{OUT} = High) Input High Level (V _{OUT} = Low)		•	2.0	1.4 1.4	0.8	V V
Logic Input Current	$V_{IN} = V_{CC}$ $V_{IN} = 0V$		•		-20	5 -40	μΑ μΑ
Output Short-Circuit Current	V _{OUT} = 0V				±10		mA
Output Leakage Current	Shutdown or Driver Disable or V _{CC} = 0V ($V_{OUT} = \pm 20V$	Note 3,4),	•		±10	±500	μA

sn1385 1385fas



DC ELECTRICAL CHARACTERISTICS The \bullet denotes specifications which apply over the full operating temperature range. V_{CC} = 3.3V, C1 = C2 = C3 = C4 = 0.1 μ F, V_{ON/OFF} = V_{CC}, Driver Disable = V_{CC}, unless noted.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Any Receiver	I					
Input Voltage Thresholds	Input Low Threshold Input High Threshold	•	0.8	1.3 1.7	2.4	V V
Hysteresis		•	0.1	0.4	1.0	V
Input Resistance	$-10V \le V_{IN} \le 10V$		3	5	7	kΩ
Output Voltage	Output Low, $I_{OUT} = -1.6$ mA (V _{CC} = 3.3V) Output High, $I_{OUT} = 160\mu$ A (V _{CC} = 3.3V)	• •	3.0	0.2 3.2	0.4	V V
Output Short-Circuit Current	Sinking Current, V _{OUT} = V _{CC} Sourcing Current, V _{OUT} = 0V		-5 2	-20 7		mA mA
Output Leakage Current	Shutdown (Note 4), $0V \le V_{OUT} \le V_{CC}$	•		1	10	μA
Power Supply Generator		•				
V ⁺ Output Voltage	I _{OUT} = 0mA I _{OUT} = 5mA			5.7 5.5		V V
V ⁻ Output Voltage	$I_{OUT} = 0mA$ $I_{OUT} = -5mA$			-5.3 -5.0		V V
Supply Rise Time	Shutdown or Driver Disable to Turn-On			0.2		ms
Power Supply						
V _{CC} Supply Current	No Load (Note 2), 0°C to 70°C No Load (Note 2), -40°C to 85°C	• •		0.2 3.5	0.5 1.0	mA mA
Supply Leakage Current (V_{CC})	Shutdown (Note 4) Driver Disable (Note 3)	•		0.2 35	10 50	μA μA
Digital Input Threshold Low		•		1.4	0.8	V
Digital Input Threshold High		•	2.0	1.4		V

AC CHARACTERISTICS The \bullet denotes specifications which apply over the full operating temperature range. $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1 \mu F$, unless noted.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Slew Rate	R _L = 3k, C _L = 51pF			8	30	V/µs
	$R_{L} = 3k, C_{L} = 1000pF$		3	5		V/µs
Driver Propagation Delay	t _{HLD} (Figure 1)	•		2	3.5	μs
(TTL to EIA/TIA-562)	t _{LHD} (Figure 1)	•		2	3.5	μs
Receiver Propagation Delay	t _{HLR} (Figure 2)	•		0.3	0.8	μs
(EIA/TIA-562 to TTL)	t _{LHR} (Figure 2)	•		0.2	0.8	μs

Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

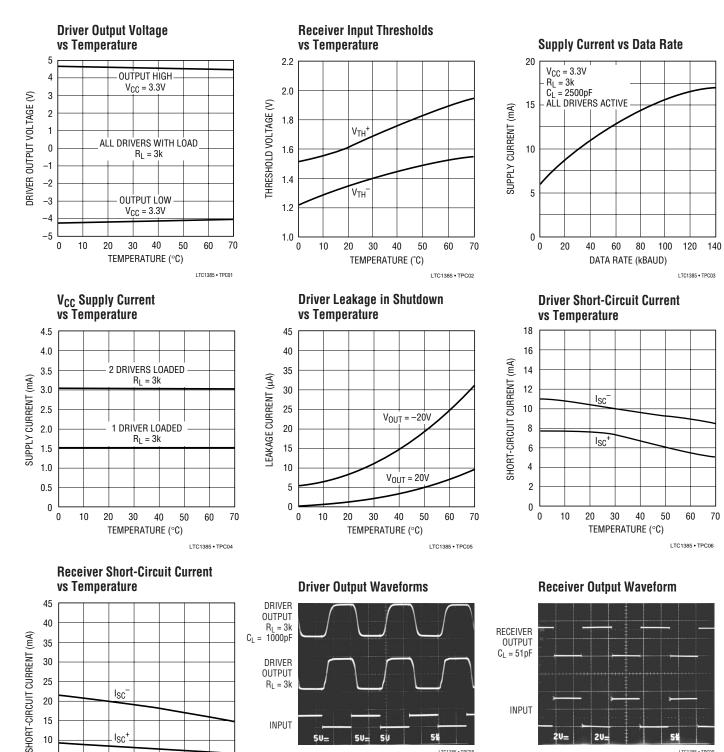
Note 2: Supply current is measured with driver and receiver outputs unloaded.

Note 3: Measurements made in the Driver Disable mode are performed with $V_{DRIVER DISABLE} = GND$ and $V_{ON/\overline{OFF}} = V_{CC}$.

Note 4: Measurements made in the Shutdown mode are performed with $V_{ON/\overline{OFF}} = 0V.$



TYPICAL PERFORMANCE CHARACTERISTICS



INPUT

50:

50: 5

LTC1385 • TPC09

5

20-

20

5

LTC1385 • TPC08

sn1385 1385fas



10

5 0 0 10 20 30 40 50 60 70

 I_{SC}^+

TEMPERATURE (°C)

LTC1385 • TPC06

PIN FUNCTIONS

 V_{CC} : 3.3V Input Supply Pin. This pin should be decoupled with a 0.1 μF ceramic capacitor.

GND: Ground Pin.

ON/OFF: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode independent of the Driver Disable pin. The supply current drops to 0.2µA and all driver and receiver outputs are forced into three-state.

DRIVER DISABLE: TTL/CMOS Compatible Input Pin. With the ON/OFF pin held high, a logic low forces the part into the Driver Disable mode with the charge pump turned off and the driver outputs forced into three-state. Both receivers remain active and the supply current drops to 35μ A. A logic high forces the part into the Normal mode.

V⁺: Positive Supply Output (EIA/TIA-562 Drivers). $V^+ \cong 2V_{CC} - 1V$. This pin requires an external capacitor $C = 0.1 \mu F$ for charge storage. The capacitor may be tied to ground or V_{CC}. With multiple devices, the V⁺ and V⁻ pins may share a common capacitor. For a large number of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output (EIA/TIA-562 Drivers). V⁻ \cong -(2V_{CC} - 1.3V). This pin requires an external capacitor C = 0.1µF for charge storage. **C1⁺, C1⁻, C2⁺, C2⁻:** Commutating Capacitor Inputs. These pins require two external capacitors $C = 0.1 \mu$ F: one from C1⁺ to C1⁻, and another from C2⁺ to C2⁻. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 2 Ω .

TR IN: EIA/TIA-562 Driver Input Pins. Inputs are TTL/ CMOS compatible. The inputs of unused drivers can be left unconnected since 300k input pull-up resistors to V_{CC} are included on chip. To minimize power consumption, the internal driver pull-up resistors are disconnected from V_{CC} in the Shutdown mode.

TR OUT: Driver Outputs at EIA/TIA-562 Voltage Levels. Outputs are in a high impedance state when in the Shutdown or Driver Disable mode or $V_{CC} = 0V$. The driver outputs are protected against ESD to $\pm 10kV$ for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to $\pm 25V$ without damage. The receiver inputs are protected against ESD to $\pm 10kV$ for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in the Shutdown mode.

SWITCHING TIME WAVEFORMS

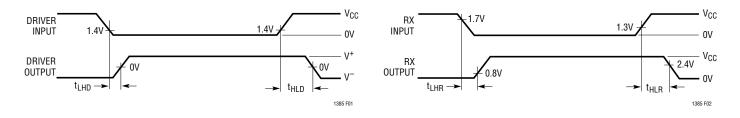


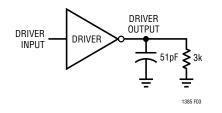
Figure 1. Driver Propagation Delay Timing

Figure 2. Receiver Propagation Delay Timing

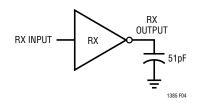


TEST CIRCUITS

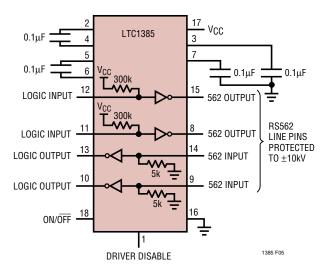
Driver Timing Test Load



Receiver Timing Test Load



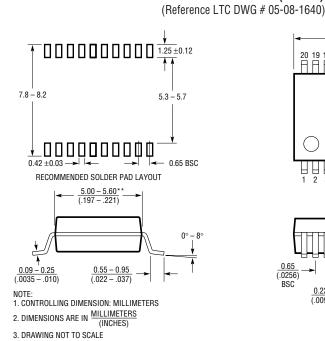




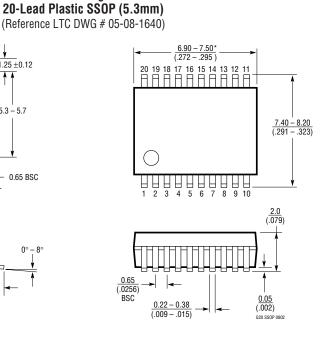




PACKAGE DESCRIPTION

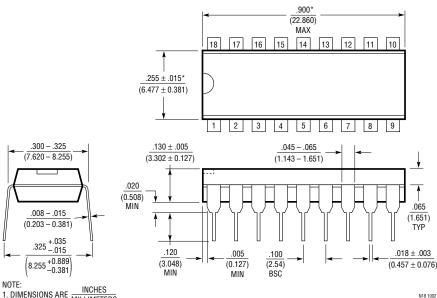


*DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .152mm (.006°) PER SIDE **DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED .254mm (.010°) PER SIDE



N Package 18-Lead PDIP (Narrow .300 Inch) (Reference LTC DWG # 05-08-1510)

G Package



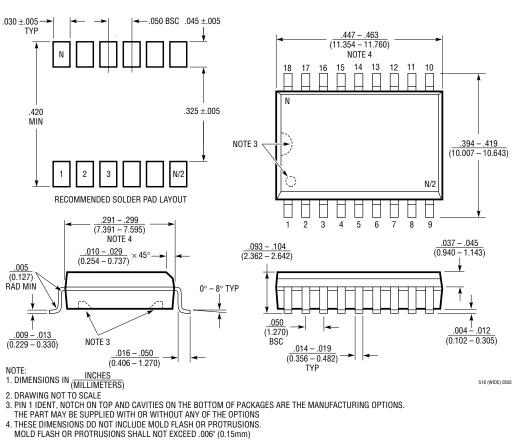
1. DIMENSIONS ARE <u>INCHES</u> MILLIMETERS

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

sn1385 1385fas

PACKAGE DESCRIPTION



SW Package 18-Lead Plastic Small Outline (Wide .300 Inch) (Reference LTC DWG # 05-08-1620)

RELATED PARTS

8

PART NUMBER	DESCRIPTION	COMMENTS
LT1780/LT1781	5V, 2 Driver, 2 Receiver RS232 Transceivers	± 15 kV ESD per IEC 1000-4
LTC1327	3.3V, 3 Driver, 5 Receiver RS562 Transceiver	300µA Supply Current, 0.2µA in Shutdown
LTC1348	3.3V to 5V, 3 Driver, 5 Receiver RS232 Transceiver	True RS232 on 3.3V, 5 Receivers Active in Shutdown
LTC1382	5V, 2 Driver, 2 Receiver RS232 Transceiver	200µA Supply Current, 0.2µA in Shutdown
LTC1383	5V, 2 Driver, 2 Receiver RS232 Transceiver	200µA Supply Current, Narrow 16-Pin SO
LTC1384	5V, 2 Driver, 2 Receiver RS232 Transceiver	200µA Supply Current, 2 Receivers Active in Shutdown
LTC1386	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200µA Supply Current, Narrow 16-Pin SO

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

LTC1385CG#TRPBF LTC1385IG#TRPBF LTC1385ISW LTC1385CSW#PBF LTC1385CN LTC1385IN LTC1385ISW#PBF LTC1385IG LTC1385IG#PBF LTC1385ISW#TR LTC1385CG#PBF LTC1385IN#PBF LTC1385CSW#TRPBF LTC1385CG#TR LTC1385IG#TR LTC1385CG LTC1385CSW#TR LTC1385CN#PBF LTC1385CSW LTC1385ISW#TRPBF